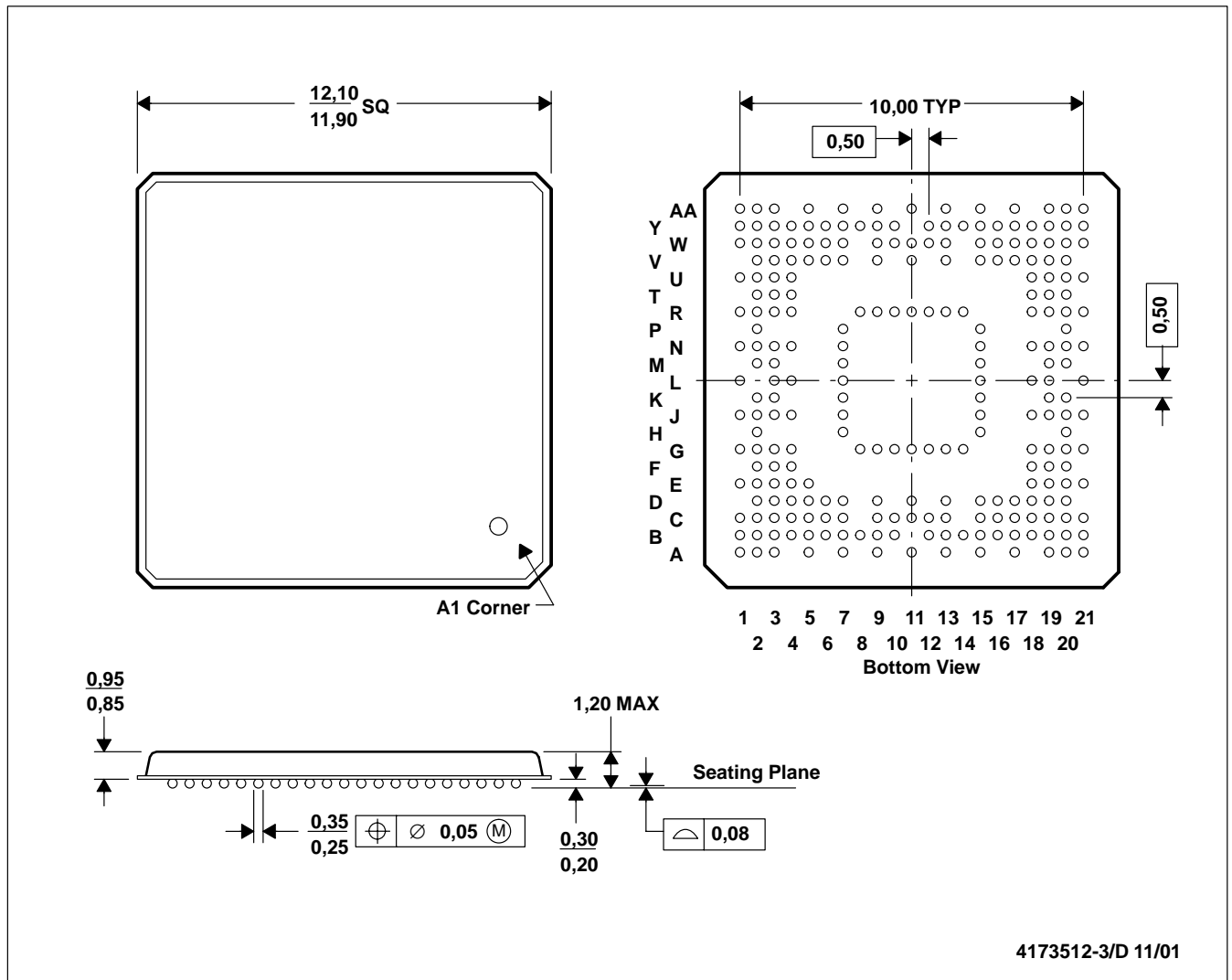


GZG (S-PBGA-N241)

PLASTIC BALL GRID ARRAY



4173512-3/D 11/01

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. MicroStar BGA™ configuration

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